

DATA SHEET

SKY67014-396LF: 1.5 to 3.0 GHz Low-Noise, Low-Current Amplifier

Applications

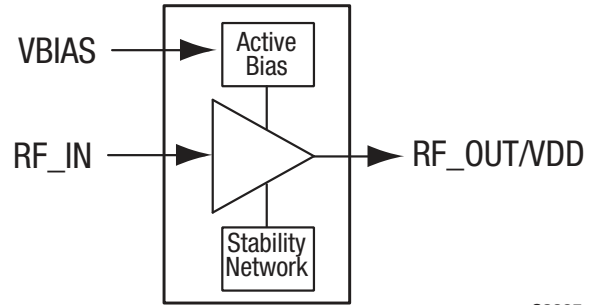
- ISM band Bluetooth® and WLAN receiver systems
- General purpose LNAs

Features

- Low Evaluation Board NF: 0.85 dB @ 2.45 GHz
- Gain: 13 dB @ 2.45 GHz
- Adjustable supply current for higher IIP3
- Incorporates on-die stability structures
- Miniature DFN (8-pin, 2 x 2 mm) package (MSL1 @ 260 °C per JEDEC J-STD-020)



Skyworks Green™ products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green™*, document number SQ04-0074.



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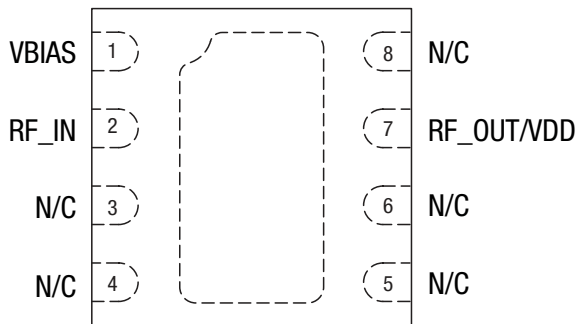
Figure 1. SKY67014-396LF Block Diagram

Description

The SKY67014-396LF is a GaAs, pHEMT low-noise amplifier (LNA) with an integrated active bias. The advanced GaAs pHEMT enhancement mode process provides excellent return loss, low noise, and high linearity.

The device offers the ability to externally adjust the supply current. The supply voltage is applied to the RF_OUT/VDD pin through an RF choke inductor. The VBIAS pin should be connected to the RF_OUT/VDD pin through an external resistor to control the supply current. Both RF_OUT/VDD and RF_IN pins should be DC blocked to ensure proper operation.

The SKY67014-396LF is manufactured in a compact, 2 x 2 mm, 8-pin Dual Flat No-Lead (DFN) package. A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.



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Figure 2. SKY67014-396LF Pinout – 8-Pin DFN (Top View)

Table 1. SKY67014-396LF Signal Descriptions

Pin	Name	Description	Pin	Name	Description
1	VBIAS	Bias for first stage amplifier. External resistor sets current consumption.	5	N/C	No connection. May be connected to ground with no change in performance.
2	RF_IN	RF input. DC blocking capacitor required.	6	N/C	No connection. May be connected to ground with no change in performance.
3	N/C	No connection. May be connected to ground with no change in performance.	7	RF_OUT/VDD	RF output. Apply VDD through RF choke inductor. DC blocking capacitor required.
4	N/C	No connection. May be connected to ground with no change in performance.	8	N/C	No connection. May be connected to ground with no change in performance.

Table 2. SKY67014-396LF Absolute Maximum Ratings (Note 1)

Parameter	Symbol	Minimum	Typical	Maximum	Units
Supply voltage	V _{DD}			5.5	V
Drain current	I _{DD}			40	mA
RF input power	P _{IN}			+18	dBm
Storage temperature	T _{STG}	-65	+25	+125	°C
Operating temperature	T _A	-40	+25	+85	°C
Thermal resistance	Θ _{JC}		128		°C/W
Electrostatic discharge:	ESD				
Charged Device Model (CDM), Class 4				>1000	V
Human Body Model (HBM), Class 1A				>300	V
Machine Model (MM), Class A				>30	V

Note 1: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

CAUTION: Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY67014-396LF are provided in Table 2. Electrical specifications are provided in Tables 3 and 4.

Typical performance characteristics of the SKY67014-396LF are illustrated in Figures 3 through 15 (18 mA operation) and in Figures 16 through 26 (5 mA operation).

Table 3. SKY67014-396LF Electrical Specifications (Note 1)**(V_{DD} = 3.3 V, Quiescent Current = 18 mA, T_A = +25 °C, P_{IN} = -20 dBm, Characteristic Impedance [Z₀] = 50 Ω, Tuning Optimized for 2.45 GHz, Unless Otherwise Noted)**

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
RF Specifications						
Noise figure	NF	Evaluation Board losses included		0.85	1.05	dB
Small signal gain	IS21I		12	13		dB
Input return loss	IS11I		12	15		dB
Output return loss	IS22I		8	11		dB
Reverse isolation	IS12I		20	23		dB
3 rd Order Input Intercept Point	IIP3	$\Delta f = 1$ MHz, P _{IN} = -20 dBm/tone	+12	+15		dBm
3 rd Order Output Intercept Point	OIP3	$\Delta f = 1$ MHz, P _{IN} = -20 dBm/tone	+25	+28		dBm
1 dB Input Compression Point	IP1dB		+1.5	+3.5		dBm
1 dB Output Compression Point	OP1dB		+13.5	+15.5		dBm
DC Specifications						
Supply voltage	V _{DD}		3.0	3.3	5.5	V
Supply current	I _{DD}	Set with external resistor		18		mA

Note 1: Performance is guaranteed only under the conditions listed in this table.**Table 4. SKY67014-396LF Electrical Specifications (Note 1)****(V_{DD} = 3.3 V, Quiescent Current = 5 mA, T_A = +25 °C, P_{IN} = -20 dBm, Characteristic Impedance [Z₀] = 50 Ω, Tuning Optimized for 2.45 GHz, Unless Otherwise Noted)**

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
RF Specifications						
Noise Figure	NF	Evaluation Board losses included		1.05	1.35	dB
Small signal gain	IS21I		10	12		dB
Input return loss	IS11I		11	17		dB
Output return loss	IS22I		8	13		dB
Reverse isolation	IS12I		19	22		dB
3 rd Order Input Intercept Point	IIP3	$\Delta f = 1$ MHz, P _{IN} = -20 dBm/tone	+2	+6		dBm
3 rd Order Output Intercept Point	OIP3	$\Delta f = 1$ MHz, P _{IN} = -20 dBm/tone	+14	+18		dBm
1 dB Input Compression Point	IP1dB		+3	+5		dBm
1 dB Output Compression Point	OP1dB		+14	+16		dBm
DC Specifications						
Supply voltage	V _{DD}			3.3		V
Supply current	I _{DD}	Set with external resistor	2	5	8	mA

Note 1: Performance is guaranteed only under the conditions listed in this table.

Typical Performance Characteristics

($V_{DD} = 3.3\text{ V}$, Quiescent Current = 18 mA, $T_A = +25\text{ }^\circ\text{C}$, $P_{IN} = -20\text{ dBm}$, Characteristic Impedance [Z_0] = 50 Ω , Tuning Optimized for 2.45 GHz, Unless Otherwise Noted)

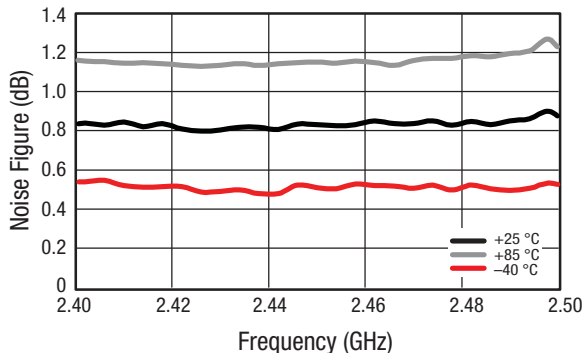


Figure 3. Noise Figure vs Frequency and Temperature, Narrow Band (Includes EVB Insertion Losses)

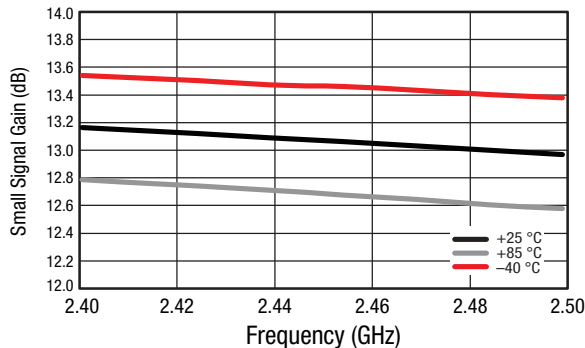


Figure 4. Small Signal Gain (IS21) vs Frequency and Temperature, Narrow Band

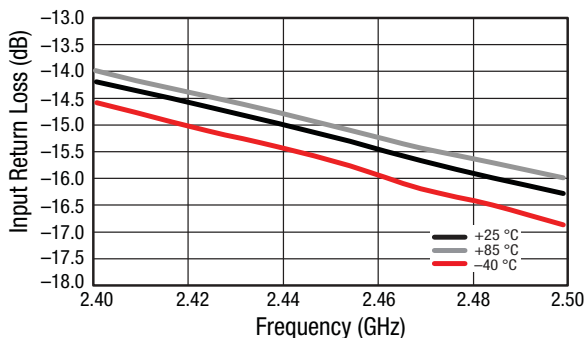


Figure 5. Small Signal Input Return Loss (IS11) vs Frequency and Temperature, Narrow Band

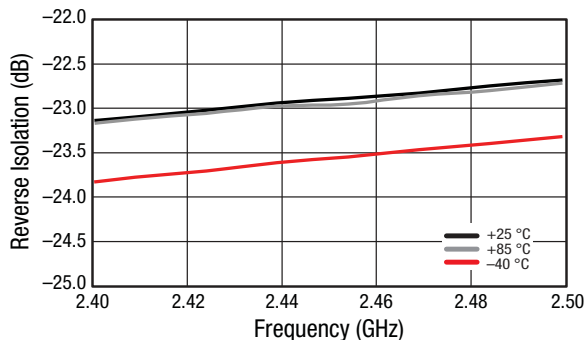


Figure 6. Small Signal Reverse Isolation (IS12) vs Frequency and Temperature, Narrow Band

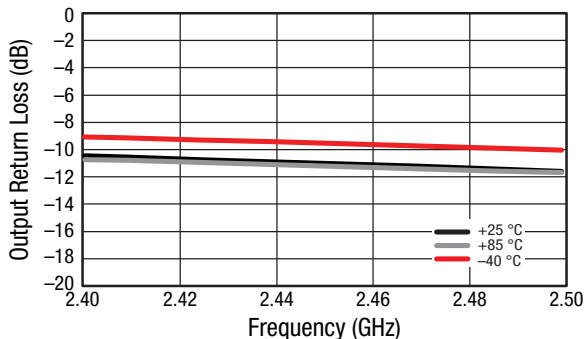


Figure 7. Small Signal Output Return Loss (IS22) vs Frequency and Temperature, Narrow Band

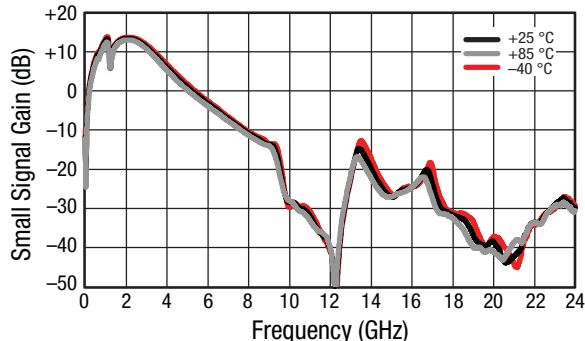


Figure 8. Small Signal Gain (IS21) vs Frequency and Temperature, Wide Band

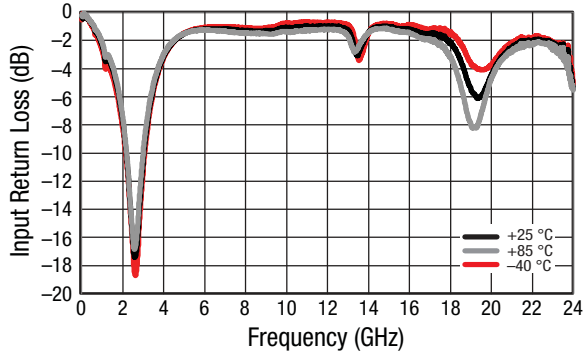


Figure 9. Small Signal Input Return Loss (| S11 |) vs Frequency and Temperature, Wide Band

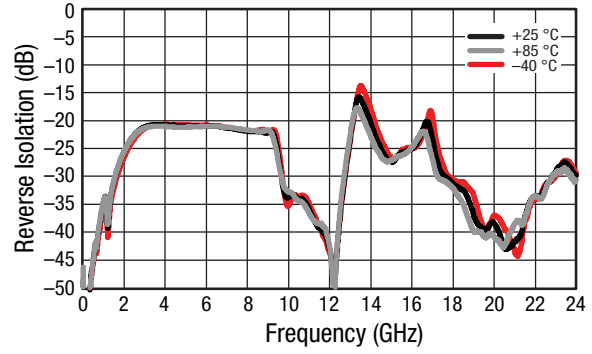


Figure 10. Small Signal Reverse Isolation (| S12 |) vs Frequency and Temperature, Wide Band

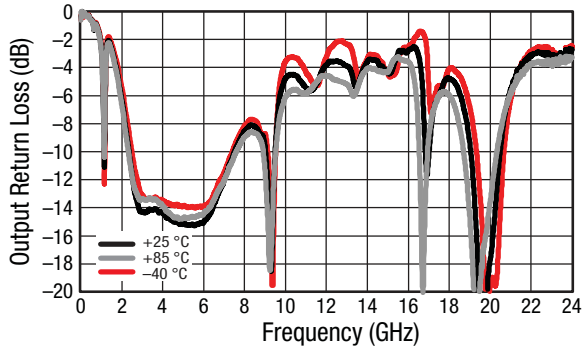


Figure 11. Small Signal Output Return Loss (| S22 |) vs Frequency and Temperature, Wide Band

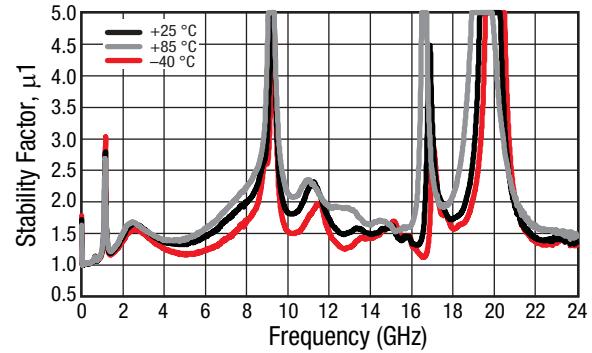


Figure 12. Stability Factor (μ_1) vs Frequency and Temperature, Wide Band

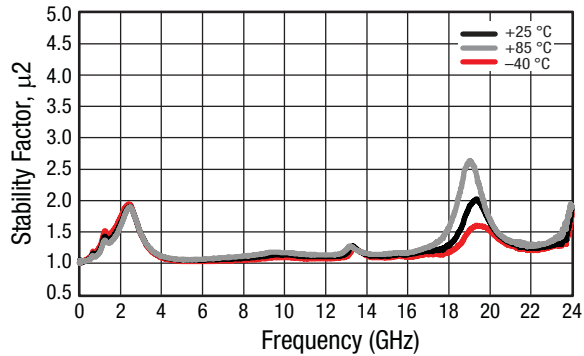


Figure 13. Stability Factor (μ_2) vs Frequency and Temperature, Wide Band

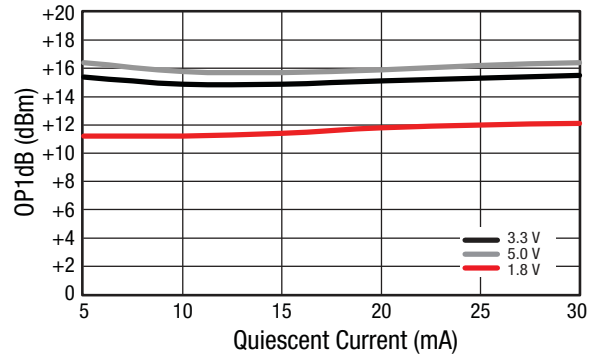


Figure 14. OP1dB vs Quiescent Current and Voltage

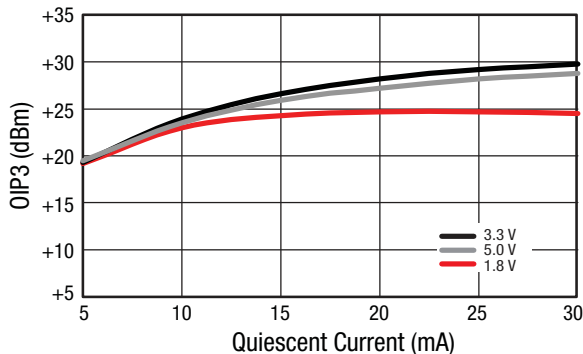


Figure 15. OIP3 vs Quiescent Current and Voltage

Typical Performance Characteristics

(VDD = 3.3 V, Quiescent Current = 5 mA, TA = +25 °C, PIN = -20 dBm, Characteristic Impedance [Zo] = 50 Ω, Tuning Optimized for 2.45 GHz, Unless Otherwise Noted)

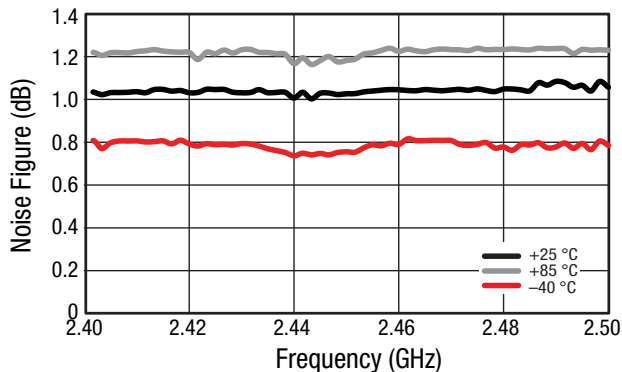


Figure 16. Noise Figure vs Frequency and Temperature, Narrow Band (Includes EVB Insertion Losses)

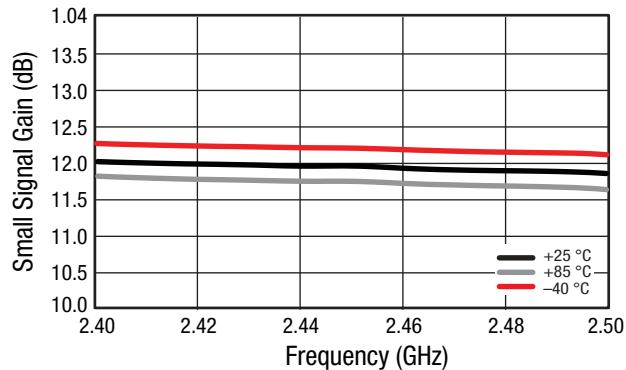


Figure 17. Small Signal Gain (IS21) vs Frequency and Temperature, Narrow Band

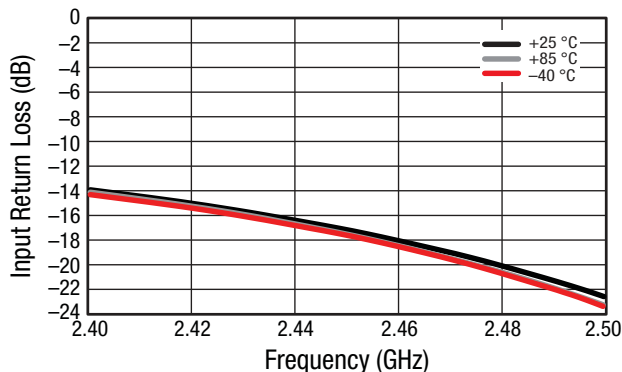


Figure 18. Small Signal Input Return Loss (IS11) vs Frequency and Temperature, Narrow Band

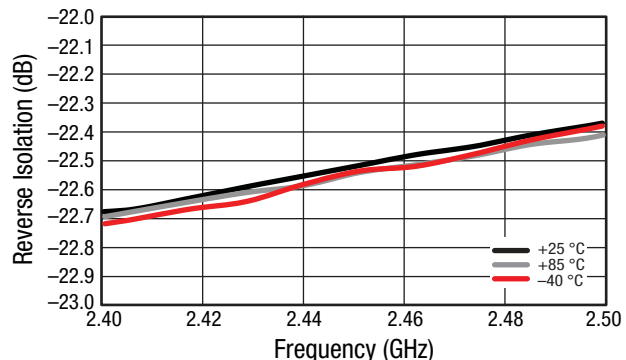


Figure 19. Small Signal Reverse Isolation (IS12) vs Frequency and Temperature, Narrow Band

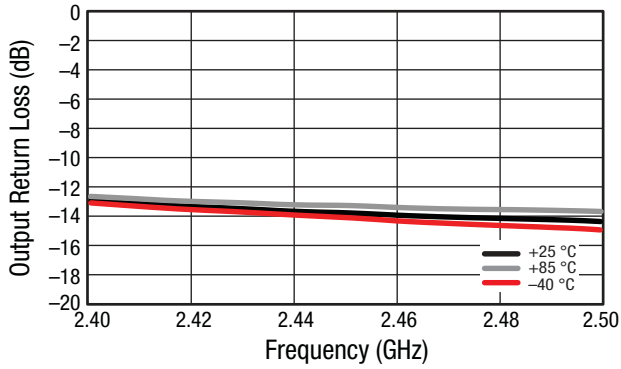


Figure 20. Small Signal Output Return Loss (S22) vs Frequency and Temperature, Narrow Band

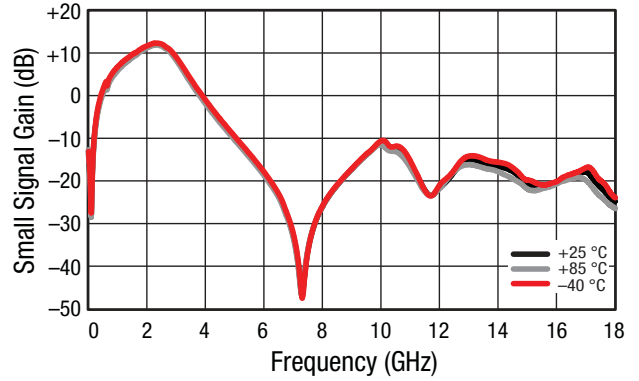


Figure 21. Small Signal Gain (S21) vs Frequency and Temperature, Wide Band

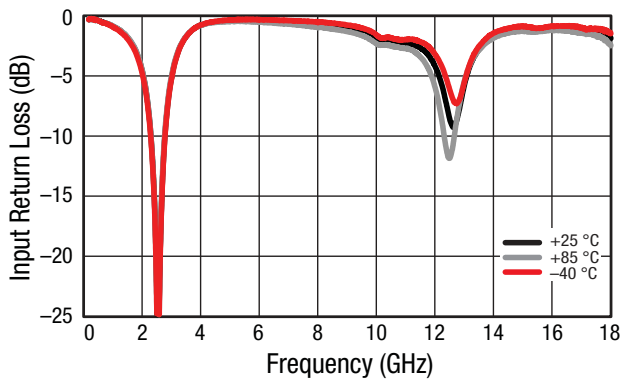


Figure 22. Small Signal Input Return Loss (S11) vs Frequency and Temperature, Wide Band

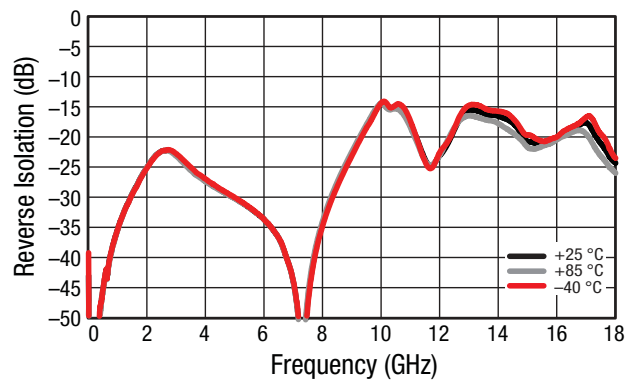


Figure 23. Small Signal Reverse Isolation (S12) vs Frequency and Temperature, Wide Band

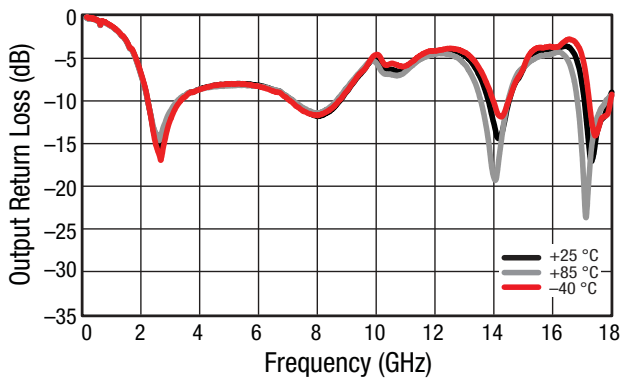


Figure 24. Small Signal Output Return Loss (S22) vs Frequency and Temperature, Wide Band

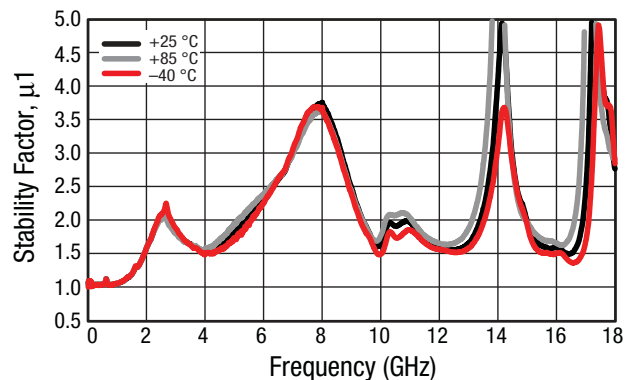


Figure 25. Stability Factor (μ_1) vs Frequency and Temperature, Wide Band

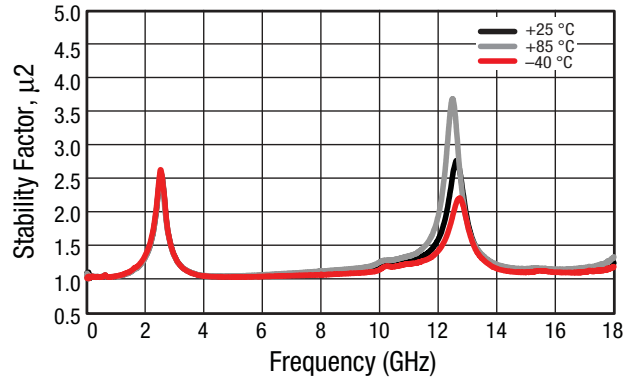


Figure 26. Stability Factor (μ2) vs Frequency and Temperature, Wide Band

Evaluation Board Description

The SKY67014-396LF Evaluation Board is used to test the performance of the SKY67014-396LF LNA. An assembly drawing for the Evaluation Board is shown in Figure 27. An Evaluation Board schematic diagram is provided in Figure 28.

Table 5 provides the Bill of Materials (BOM) list for Evaluation Board components needed for 18 mA operation (for applications that use a bias current ≥ 12 mA). Table 6 provides the BOM list for Evaluation Board components needed for 5 mA operation (for applications that use a bias current < 12 mA).

Package Dimensions

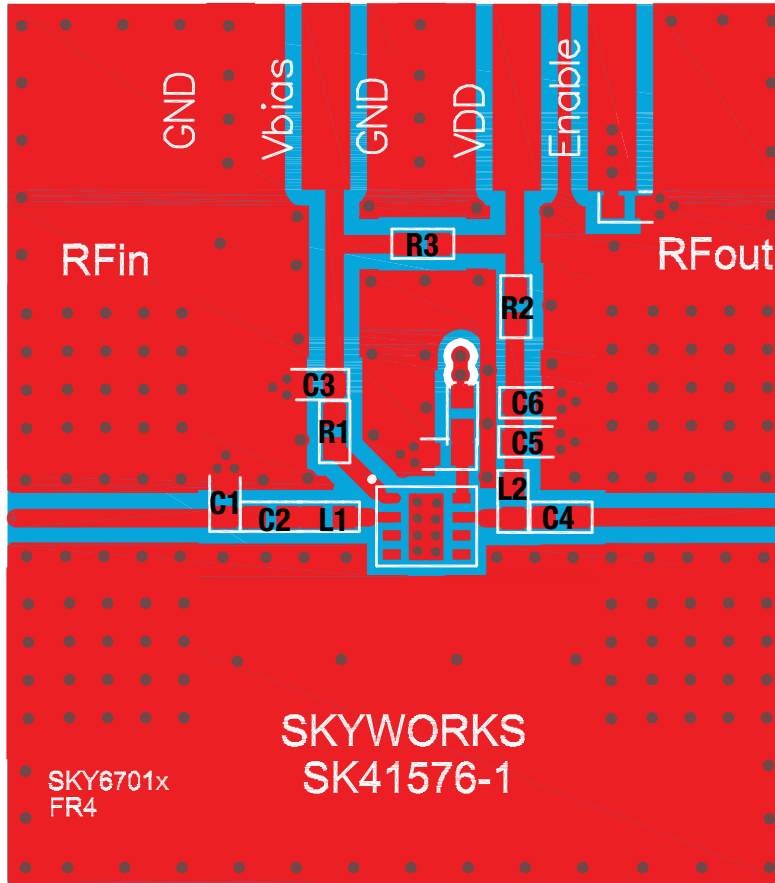
The PCB layout footprint for the SKY67014-396LF is provided in Figure 29. Typical case markings are shown in Figure 30. Package dimensions for the 8-pin DFN are shown in Figure 31, and tape and reel dimensions are provided in Figure 32.

Package and Handling Information

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY67014-396LF is rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.



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Figure 27. SKY67014-396LF Evaluation Board Assembly Diagram

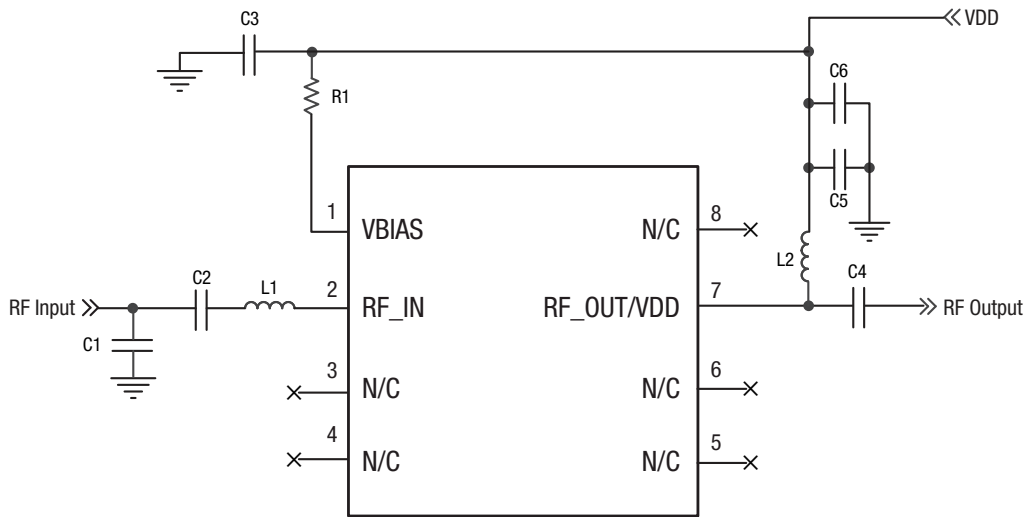


Figure 28. SKY67014-396LF Evaluation Board Schematic

Table 5. SKY67014-396LF Evaluation Board Bill of Materials (18 mA Operation)

Component	Value	Size	Manufacturer	
C1	0.5 pF	0402	Murata	GJM1555C1HR50BB01D
C2	10 pF	0402	Murata	GJM1555C1H100JB01D
C3	10 pF	0402	Murata	GRM1555C1H100RZ01D
C4	0.1 μF	0402	Murata	GRM1555R71C104KA88D
C5	22 pF	0402	Murata	GRM1555C1H220JZ01
C6	10000 pF	0402	Murata	GRM155R71H103KA88
L1	2.9 nH	0402	Murata	LQW15AN2N9C00D
L2	2.2 nH	0402	Murata	LQG15HS2N2S02D
R1	2.2 kΩ	0402	Panasonic	ERJ-2GEJ222X

Note: Components R2 and R3 shown on the Evaluation Board are 0 Ω jumpers needed only for this board. Customer applications of the LINA can omit these components.

Table 6. SKY67014-396LF Evaluation Board Bill of Materials (5 mA Operation)

Component	Value	Size	Manufacturer	
C1	1.2 pF	0402	Murata	GJM1555C1H1R2CB01
C2	10 pF	0402	Murata	GJM1555C1H100JB01D
C3	10 pF	0402	Murata	GRM1555C1H100RZ01D
C4	22 pF	0402	Murata	GRM1555C1H220JZ01
C5	1000 pF	0402	Murata	GRM1555C1H102JA01
C6	0.5 pF	0402	Murata	GRM155C1HR50BZ01
L1	2.9 nH	0402	Murata	LQW15AN2N9C00D
L2	2.2 nH	0402	Murata	LQG15HS2N2S02D
R1	10 kΩ	0402	Panasonic	ERJ-2GEJ103X

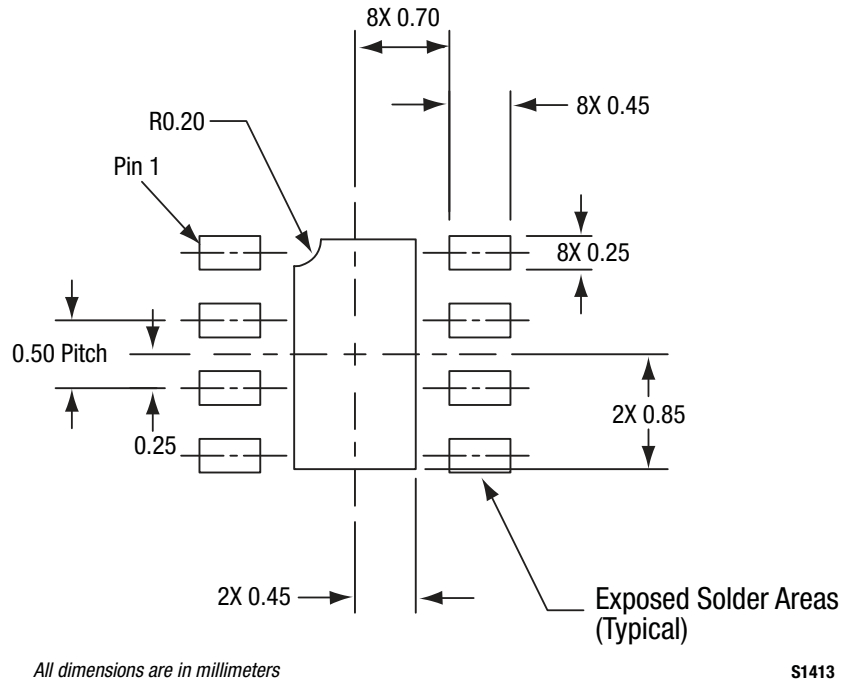


Figure 29. SKY67014-396LF PCB Layout Footprint (Top View)

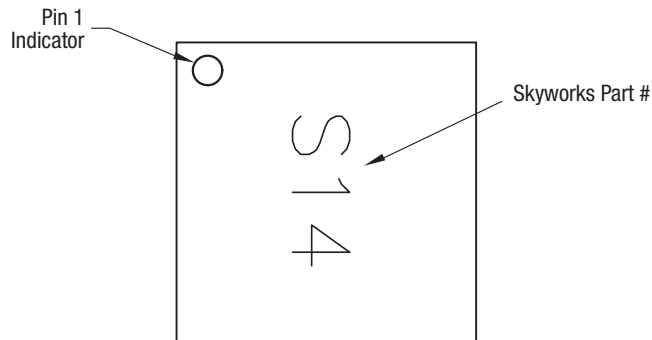
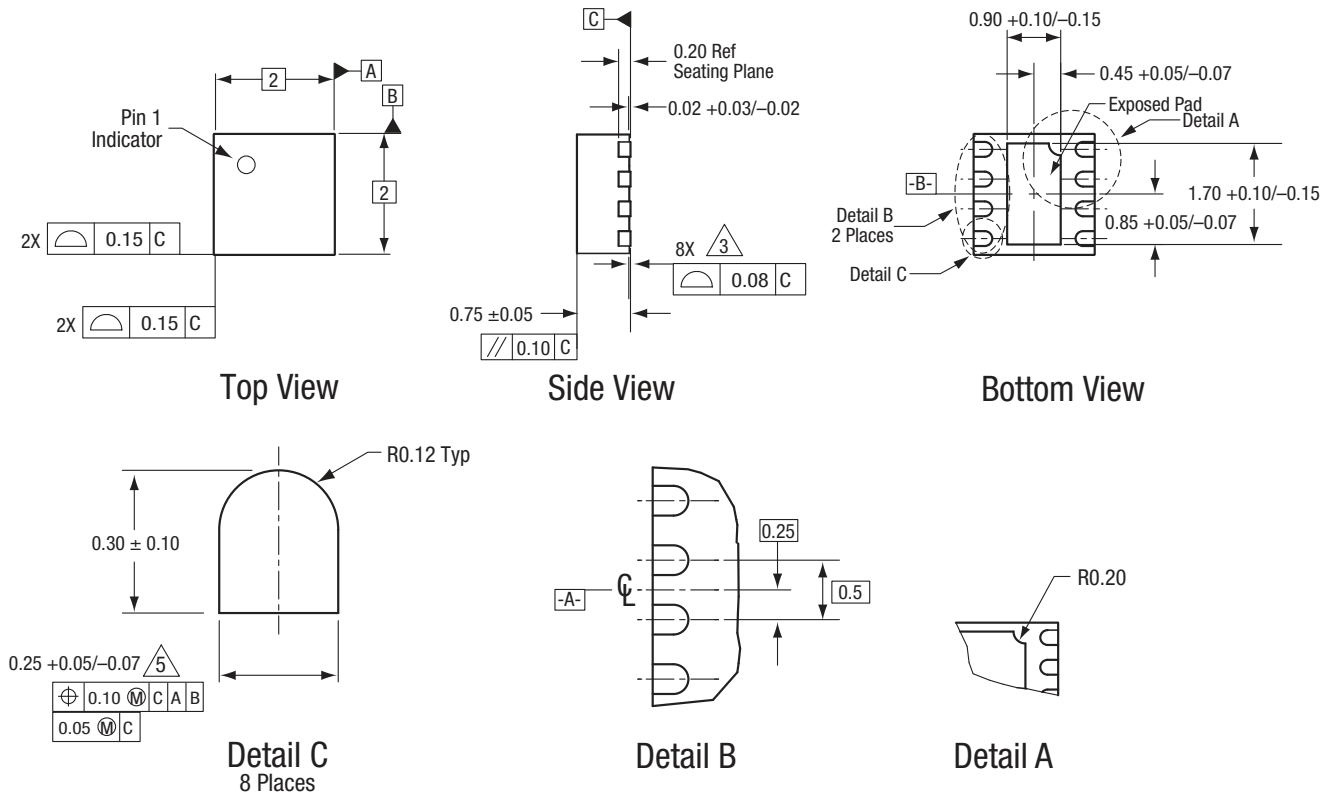


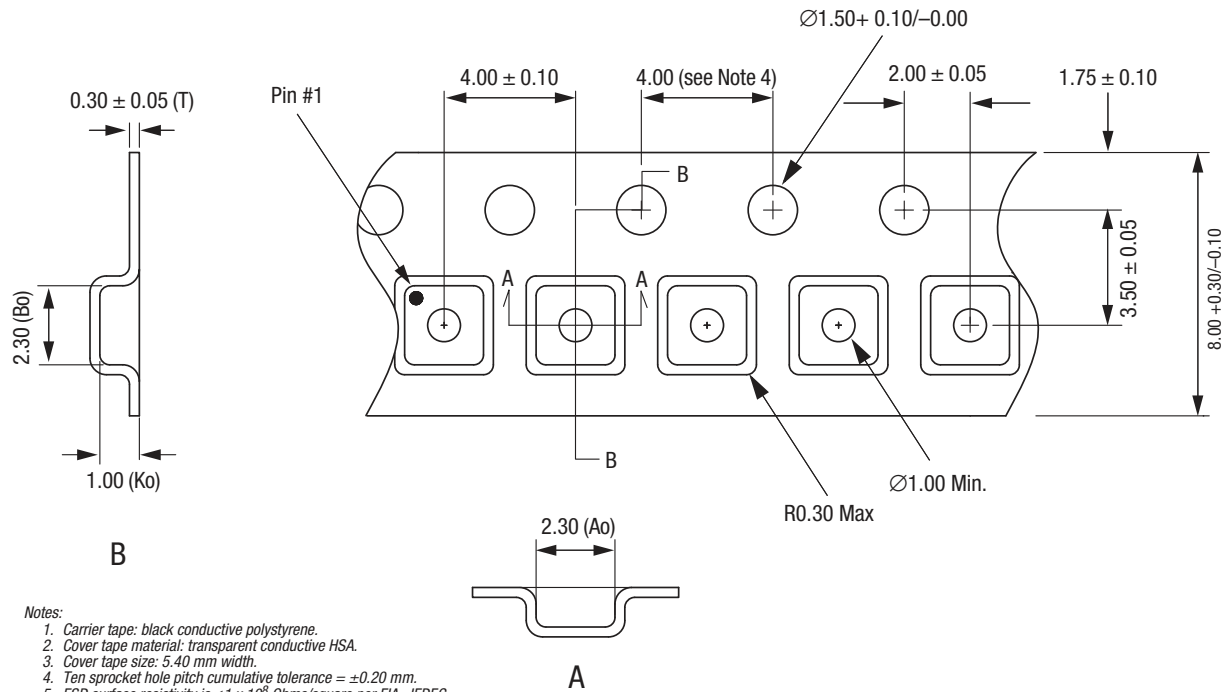
Figure 30. Typical Case Markings (Top View)



All measurements are in millimeters.
 Dimensioning and tolerancing according to ASME Y14.5M-1994.
 Coplanarity applies to the exposed heat sink slug as well as the terminals..
 Plating requirement per source control drawing (SCD) 2504.
 Dimension applies to metallized terminal and is measured between 0.15 mm and 0.30 mm from terminal tip.

S1945

Figure 31. SKY67014-396LF 8-Pin DFN Package Dimensions



- Notes:
1. Carrier tape: black conductive polystyrene.
 2. Cover tape material: transparent conductive HSA.
 3. Cover tape size: 5.40 mm width.
 4. Ten sprocket hole pitch cumulative tolerance = ±0.20 mm.
 5. ESD surface resistivity is $\leq 1 \times 10^9$ Ohms/square per EIA, JEDEC tape and reel specification.
 6. Ao and Bo measurement point to be 0.30 mm from bottom pocket.
 7. All measurements are in millimeters.

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Figure 32. SKY67014-396LF Tape and Reel Dimensions

Ordering Information

Model Name	Manufacturing Part Number	Evaluation Board Part Number
SKY67014-396LF LNA	SKY67014-396LF	SKY67014-396LF-EVB (18 mA) SKY67014-396LF-EVB (5 mA)

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